

# ALUMINUM ELECTROLYTIC CAPACITORS

nichicon

**UCJ**

Chip Type, High Reliability.  
Low temperature ESR specification.



For SMD



Long Life



Anti-Solvent  
Feature

- Chip type, high temperature range, for +125°C use.
  - Added ESR specification after the test at -40°C  
(φ6.3 sizes provide only for the first stage.)
  - Applicable to automatic mounting machine fed with carrier tape.
  - Compliant to the RoHS directive (2011/65/EU).
  - AEC-Q200 compliant.
- Please contact us for details.

UCZ

Low ESR  
Long Life

**UCJ**

Added ESR specification  
at -40°C

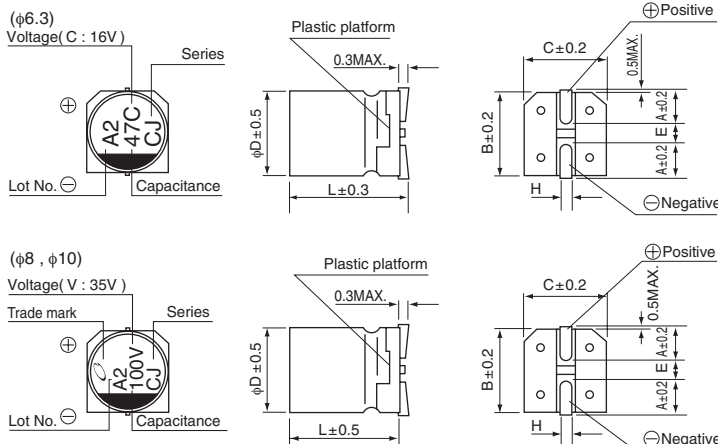
UUB



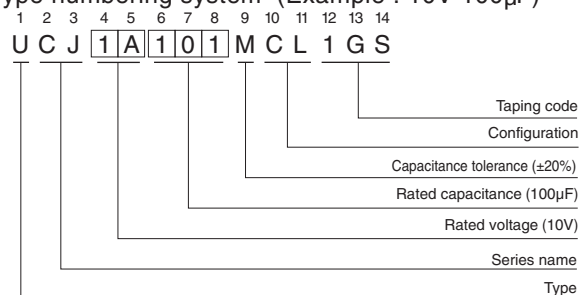
## Specifications

Item	Performance Characteristics						
Category Temperature Range	-40 to +125°C						
Rated Voltage Range	10 to 50V						
Rated Capacitance Range	10 to 470μF						
Capacitance Tolerance	±20% at 120Hz, 20°C						
Leakage Current	After 1 minute's application of rated voltage at 20°C, leakage current is not more than 0.03CV or 4(μA) , whichever is greater.						
Tangent of loss angle (tan δ)	Measurement frequency : 120Hz at 20°C						
	Rated voltage (V)	10	16	25	35	50	
	tan δ (MAX.)	0.32	0.24	0.21	0.18	0.18	
Stability at Low Temperature	Measurement frequency : 120Hz						
	Rated voltage (V)		10	16	25	35	50
	Impedance ratio ZT / Z20 (MAX.)	Z-40°C / Z+20°C	12	8	6	4	4
Endurance	The specifications listed at right shall be met when the capacitors are restored to 20°C after the rated voltage is applied for 2000 hours at 125°C.				Capacitance change		Within ±30% of the initial capacitance value
					tan δ		300% or less than the initial specified value
					Leakage current		Less than or equal to the initial specified value
Shelf Life	After storing the capacitors under no load at 125°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.						
Resistance to soldering heat	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C. The capacitors shall meet the characteristic requirements listed at right when they are removed from the plate and restored to 20°C.				Capacitance change		Within ±10% of the initial capacitance value
					tan δ		Less than or equal to the initial specified value
					Leakage current		Less than or equal to the initial specified value
Marking	Black print on the case top.						

## Chip Type



## Type numbering system (Example : 10V 100μF)



φD × L	6.3 × 8.7	8 × 10	10 × 10
A	2.4	2.9	3.2
B	6.6	8.3	10.3
C	6.6	8.3	10.3
E	2.2	3.1	4.5
L	8.7	10	10
H	0.5 to 0.8	0.8 to 1.1	0.8 to 1.1

Voltage	10	16	25	35	50
Code	A	C	E	V	H

## Dimensions

Cap.(μF) \ V	10	16			25			35			50										
	1A	1C			1E			1V			1H										
10	100										6.3×8.7	14	–	95	6.3×8.7	14	–	95			
22	220							6.3×8.7	14	–	95	6.3×8.7	14	–	95	6.3×8.7	14	–	95		
33	330							6.3×8.7	14	–	95	6.3×8.7	14	–	95	8×10	2.0	6.0	200		
47	470				6.3×8.7	14	–	95	6.3×8.7	14	–	95	6.3×8.7	14	–	95	10×10	1.5	4.5	330	
100	101	6.3×8.7	14	–	95	8×10	2.0	6.0	250	8×10	2.0	6.0	250	10×10	1.5	4.5	400	10×10	1.5	4.5	330
220	221	8×10	2.0	6.0	250	10×10	1.5	4.5	400	10×10	1.5	4.5	400	10×10	1.5	4.5	400	Case size φD×L (mm)	Initial endurance test	Rate ripple	
330	331	10×10	1.5	4.5	400	10×10	1.5	4.5	400	10×10	1.5	4.5	400								
470	471	10×10	1.5	4.5	400																

## Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Coefficient	0.35	0.50	0.64	0.83	1.00

Max. ESR (Ω) at -40°C 100kHz, Rated ripple current (mA<sub>rms</sub>) at 125°C 100kHz

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please refer to page 3 for the minimum order quantity.